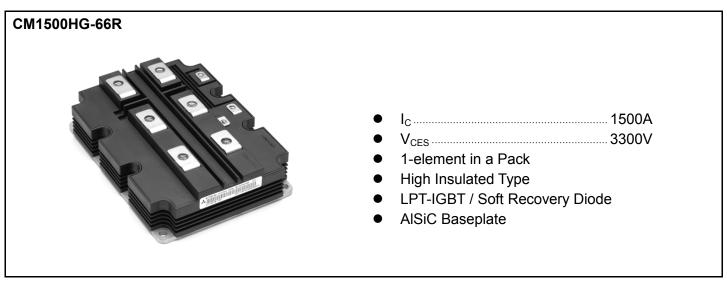


< HVIGBT MODULES >

CM1500HG-66R

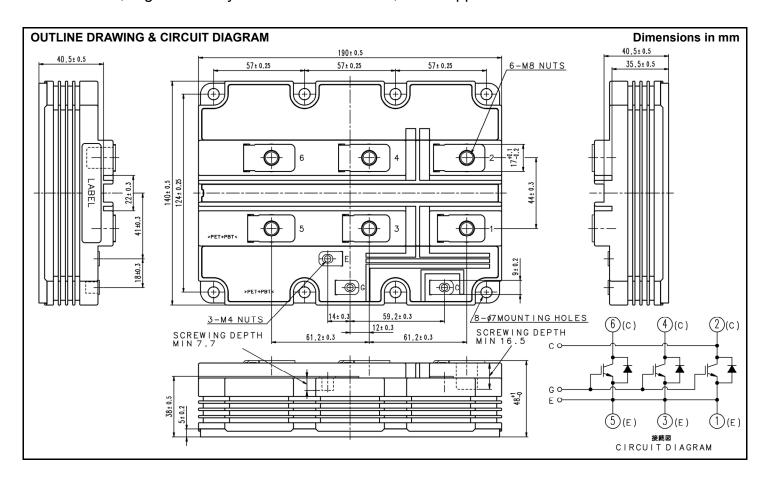
HIGH POWER SWITCHING USE INSULATED TYPE

4th-Version HVIGBT (High Voltage High Insulated Gate Bipolar Transistor) Modules



APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers



4th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

MAXIMUM RATINGS

Symbol	Item	Conditions	Ratings	Unit
M	Collector-emitter voltage	$V_{GE} = 0V, T_j = -40+150^{\circ}C$	3300	V
V _{CES}	Collector-emitter voltage	$V_{GE} = 0V, T_j = -50^{\circ}C$	3200	V
V_{GES}	Gate-emitter voltage	$V_{CE} = 0V, T_j = 25^{\circ}C$	± 20	V
Ic	Collector current	DC, $T_c = 90^{\circ}C$	1500	Α
I _{CRM}	Collector current	Pulse (Note 1)	3000	Α
I _E	Emitter current (Note 2)	DC	1500	Α
I _{ERM}	Emitter current (Note 2)	Pulse (Note 1)	3000	Α
P _{tot}	Maximum power dissipation (Note 3)	T _c = 25°C, IGBT part	14700	W
V _{iso}	Isolation voltage	RMS, sinusoidal, f = 60Hz, t = 1 min.	10200	V
V _e	Partial discharge extinction voltage	RMS, sinusoidal, f = 60Hz, Q _{PD} ≤ 10 pC	5100	V
Tj	Junction temperature		− 50 ~ +150	°C
T _{jop}	Operating junction temperature		− 50 ~ + 150	°C
T_{stg}	Storage temperature		− 55 ~ + 150	°C
t _{psc}	Short circuit pulse width	$V_{CC} = 2500V, V_{CE} \le V_{CES}, V_{GE} = 15V, T_j = 150^{\circ}C$	10	μS

ELECTRICAL CHARACTERISTICS

Symbol Item Conditions Min Typ Max	Unit
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	i Oille
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
Vose (m) Gate-emitter threshold voltage Vose = 10 V, Io = 150 mA, Tj = 25°C 5.7 6.2 6.7 Ioss Gate leakage current Vose = Voses, Vose = 0V, Tj = 25°C -0.5 -0.5 -0.5 Coses Input capacitance Coses Output capacitance Coses Reverse transfer capacitance Tj = 25°C -0.5 -0.5 Coses Reverse transfer capacitance Vose = 10 V, Vose = 0 V, F = 100 kHz -0.5 -0.5 Collector-emitter saturation voltage Vose = 1800V, Io = 1500A, Vose = ±15V -0.6 -0.5 Collector-emitter saturation voltage Vose = 1800V, Io = 1500A, Vose = ±15V -0.6 -0.5 Collector-emitter saturation voltage Vose = 1800V, Io = 1500A, Vose = ±15V -0.6 -0.5 Collector-emitter saturation voltage Vose = 1800V, Io = 1500A, Vose = ±15V -0.6 -0.5 Collector-emitter saturation voltage Vose = 1800V, Io = 1500A, Vose = ±15V -0.6 -0.3 Collector-emitter saturation voltage Vose = 1800V, Io = 1500A, Vose = ±15V -0.6 -0.5 Tight = 1.50°C -0.3.10 3.70 Tight = 1.50°C -0.3.25 -0.50 Tight = 1.50°C -0.3.25 -	mA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	μA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	nF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	nF
$ \begin{array}{c} V_{CEsst} \\ V_{CEsst} \\ \hline \\ V_{CEsst} \\ \hline \\ V_{CE} \\ \hline \\ V_{GE} \\ \hline \\ V_{CC} \\ \hline \\ V_{CC$	nF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	μC
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$) V
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$t_{r} = \begin{array}{c} T_{r} = 150^{\circ}C & - & 0.95 & 1.25 \\ T_{r} = 25^{\circ}C & - & 0.28 & - \\ T_{r} = 125^{\circ}C & - & 0.30 & 0.50 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ T_{r} = 150^{\circ}C & - & 0.40 & 1.00 \\ $	
$t_{r} = t_{r} = t_{r$	μs
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$E_{on(10\%)} \text{Turn-on switching energy} \begin{tabular}{c c c c c c c c c c c c c c c c c c c $	
$E_{on(10\%)} = \frac{1}{10000000000000000000000000000000000$) µs
$E_{on(10\%)} \text{Turn-on switching energy} \stackrel{\text{(Note 5)}}{=} \begin{cases} R_{G(on)} = 1.6 \ \Omega \\ L_s = 100 \ \text{nH} \\ \text{Inductive load} \end{cases} \begin{array}{c} T_J = 25^{\circ}\text{C} & - & 2.10 \ - \\ T_J = 125^{\circ}\text{C} & - & 2.75 \ - \\ T_J = 150^{\circ}\text{C} & - & 3.00 \ - \\ T_J = 25^{\circ}\text{C} & - & 2.20 \ - \\ T_J = 125^{\circ}\text{C} & - & 2.90 \ - \\ T_J = 125^{\circ}\text{C} & - & 2.90 \ - \\ T_J = 150^{\circ}\text{C} & - & 3.20 \ - \\ T_J = 150^{\circ}\text{C} & - & 2.70 \ - \\ T_J = 150^{\circ}\text{C} & - & 2.80 \ 3.30 \\ T_J = 150^{\circ}\text{C} & - & 2.80 \ 3.30 \\ T_J = 150^{\circ}\text{C} & - & 2.85 \ 3.30 \\ T_J = 150^{\circ}\text{C} & - & 0.30 \ - \\ T_J = 150^{\circ}\text{C} & - & 0.30 \ - \\ T_J = 150^{\circ}\text{C} & - & 0.30 \ - \\ T_J = 150^{\circ}\text{C} & - & 0.35 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.40 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.40 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.40 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.40 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.40 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.40 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.40 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.40 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.40 \ 1.00 \\ T_J = 150^{\circ}\text{C} & - & 0.245 \ - \\ T_J = 150^{\circ}\text{C} & - & 0.250 \ - \\ T_J = 150^{\circ}\text{C} & - & 0.250 \ - \\ T_J = 150^{\circ}\text{C} & - & 0.200 \ - \\ T_J = 150^{\circ}\text{C} & - & $,
$E_{on} = \begin{bmatrix} I_{on} & I_{on} &$	
$E_{on} \qquad \text{Turn-on switching energy} \qquad \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	_ J
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$t_{d(off)} \qquad \text{Turn-off delay time} \qquad \begin{array}{c} T_j = 25^{\circ}C & - & 2.70 & - \\ T_j = 125^{\circ}C & - & 2.80 & 3.30 \\ T_j = 150^{\circ}C & - & 2.85 & 3.30 \\ \hline T_j = 150^{\circ}C & - & 0.30 & - \\ \hline T_j = 125^{\circ}C & - & 0.30 & - \\ \hline T_j = 125^{\circ}C & - & 0.30 & - \\ \hline T_j = 125^{\circ}C & - & 0.30 & - \\ \hline T_j = 125^{\circ}C & - & 0.35 & 1.00 \\ \hline T_j = 150^{\circ}C & - & 0.40 & 1.00 \\ \hline T_j = 150^{\circ}C & - & 0.40 & 1.00 \\ \hline T_j = 125^{\circ}C & - & 0.40 & 1.00 \\ \hline T_j = 125^{\circ}C & - & 0.40 & - \\ \hline T_j = 125^{\circ}C & - & 0.45 & - \\ \hline T_j = 150^{\circ}C & - & 0.45 & - \\ \hline T_j = 150^{\circ}C & - & 0.20 & - \\ \hline T_j = 150^{\circ}C &$	J
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	7
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	
$ \begin{array}{c} t_f \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$) µs
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$, '
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$) µs
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$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
Inductive load $T_j = 150^{\circ}C$ 2.50 — $T_j = 25^{\circ}C$ — 2.20 —	J
$T_{j} = 25^{\circ}C$ — 2.20 —	7
(ALIVE O)	1
	J
$T_i = 150^{\circ}C$ — 2.80 —	7

< HVIGBT MODULES >

CM1500HG-66R

HIGH POWER SWITCHING USE INSULATED TYPE

4th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

ELECTRICAL CHARACTERISTICS (continuation)

Symbol	Item		Conditions Limits				Unit	
Syllibol	item		Conditions		Min	Тур	Max	Offic
			I _E = 1500 A ^(Note 4)	T _j = 25°C	_	2.15	_	
V_{EC}	Emitter-collector voltage	(Note 2)		T _j = 125°C	_	2.30	2.80	V
			$V_{GE} = 0 V$	T _j = 150°C	_	2.25	_	
				T _j = 25°C	_	0.50	_	
t _{rr}	Reverse recovery time	(Note 2)		T _j = 125°C	_	0.70		μs
				$T_{j} = 150^{\circ}C$	_	0.80	I	
	Reverse recovery current (Note 2)		V _{CC} = 1800 V	$T_j = 25^{\circ}C$	_	1250	l	Α
Im		(Note 2)		T _j = 125°C	_	1500	l	
				$T_{j} = 150^{\circ}C$	_	1550	ı	
Q _{rr}			$I_{\rm C} = 1500 \text{A}$ $V_{\rm GE} = \pm 15 \text{V}$	$T_j = 25^{\circ}C$	_	1050	-	
	Reverse recovery charge	(Note 2)	*-	T _j = 125°C	_	1700		μC
			$R_{G(on)} = 1.6 \Omega$ $L_s = 100 \text{ nH}$	$T_j = 150^{\circ}C$	_	2000	ı	
	Doverso received approximation (Note 2)	Inductive load	$T_j = 25^{\circ}C$		1.05	-		
E _{rec(10%)}	Reverse recovery energy	(Note 5)	madelive load	T _j = 125°C	_	1.75		J
				T _j = 150°C	_	2.00	l	
E _{rec}	Doverse receiver anergy (No	(Note 2)		$T_j = 25^{\circ}C$		1.20	_	j
	Reverse recovery energy	(Note 6)		$T_j = 125^{\circ}C$	_	2.00		J
				T _j = 150°C	_	2.30		

THERMAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
Syllibol	item	Conditions		Тур	Max	Offic
R _{th(j-c)Q}	Thermal resistance	Junction to Case, IGBT part	l	_	8.5	K/kW
$R_{th(j-c)D}$	Thermal resistance	Junction to Case, FWDi part			15.5	K/kW
R _{th(c-s)}	Contact thermal resistance	Case to heat sink, $\lambda_{grease} = 1W/m^*k$, $D_{(c-s)} = 100\mu m$	_	6.0	_	K/kW

MECHANICAL CHARACTERISTICS

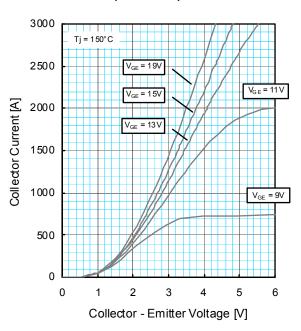
Symbol	Item	Conditions		Limits	Unit	
	item Conditions	Min	Тур	Max		
M_t		M8 : Main terminals screw	7.0	l	22.0	N⋅m
Ms	Mounting torque	M6 : Mounting screw	3.0	-	6.0	N·m
Mt		M4 : Auxiliary terminals screw	1.0	l	3.0	N⋅m
m	Mass		1	1.4	1	kg
CTI	Comparative tracking index		600	1	1	_
da	Clearance		26.0	_	_	mm
ds	Creepage distance		56.0	-	1	mm
L _{P CE}	Parasitic stray inductance		1	15.0	1	nΗ
R _{CC'+EE'}	Internal lead resistance	$T_C = 25^{\circ}C$	1	0.18	1	mΩ
r_g	Internal gate resistance	$T_C = 25^{\circ}C$	_	1.5	_	Ω

Note1. Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed T_{opmax} rating(150°C).

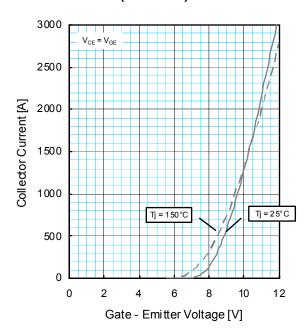
- 2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWD_i).
- 3. Junction temperature (T_j) should not exceed T_{jmax} rating (150°C).
- 4. Pulse width and repetition rate should be such as to cause negligible temperature rise.
- 5. $E_{on(10\%)}$ / $E_{off(10\%)}$ / $E_{rec(10\%)}$ are the integral of 0.1 V_{CE} x 0.1 I_C x dt.
- 6. Definition of all items is according to IEC 60747, unless otherwise specified.

PERFORMANCE CURVES

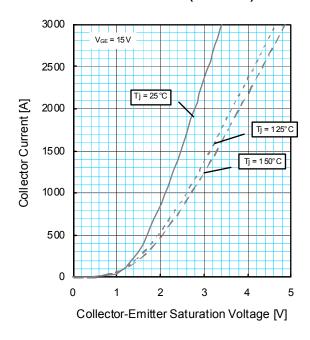
OUTPUT CHARACTERISTICS (TYPICAL)



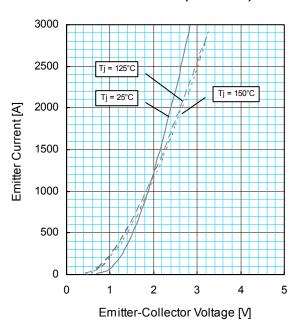
TRANSFER CHARACTERISTICS (TYPICAL)



COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



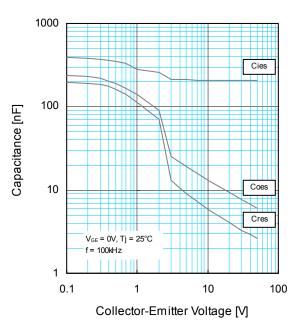
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



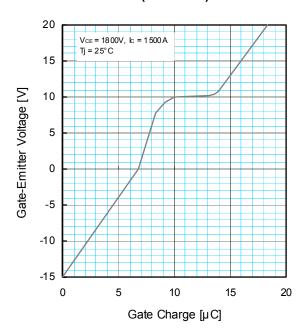
PERFORMANCE CURVES

INSULATED TYPE

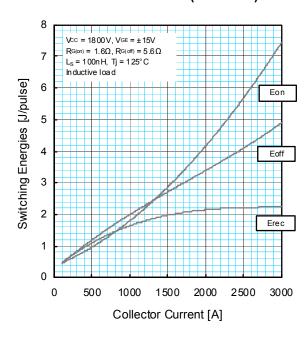
CAPACITANCE CHARACTERISTICS (TYPICAL)



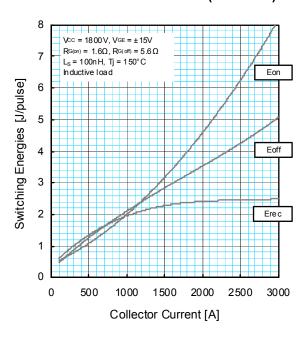
GATE CHARGE CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



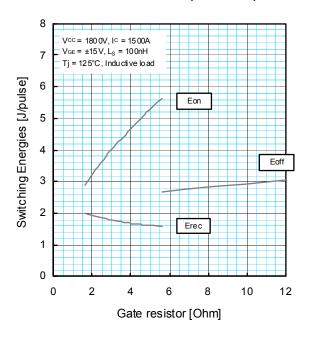
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



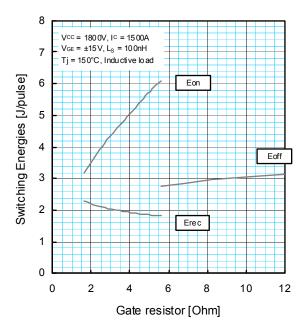
CM1500HG-66R HIGH POWER SWITCHING USE INSULATED TYPE

PERFORMANCE CURVES

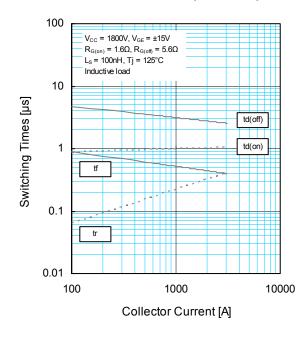
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



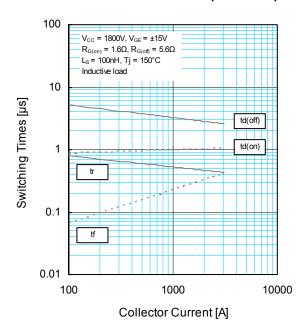
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



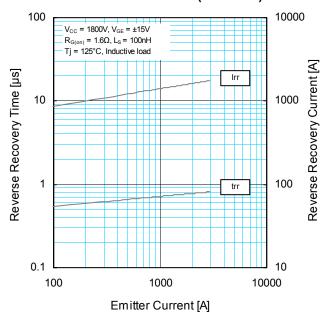
HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



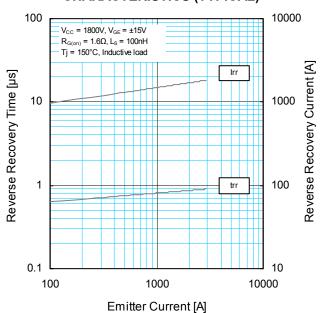
CM1500HG-66R HIGH POWER SWITCHING USE INSULATED TYPE

PERFORMANCE CURVES

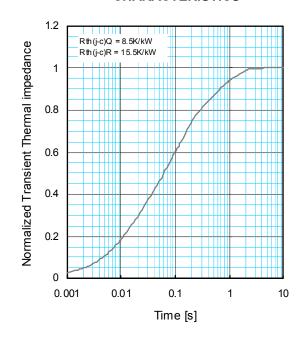
FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



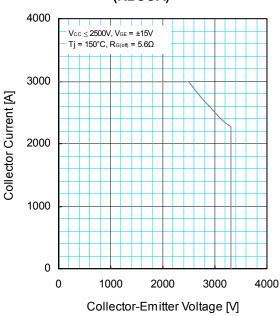
$$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_{i} \left\{ 1 - \exp\left(-\frac{t}{\tau_{i}}\right) \right\}$$

	1	2	3	4
R_i [K/kW]:	0.0055	0.2360	0.4680	0.2905
t _i [sec] :	0.0001	0.0131	0.0878	0.6247

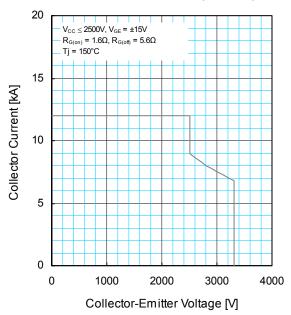
PERFORMANCE CURVES

INSULATED TYPE

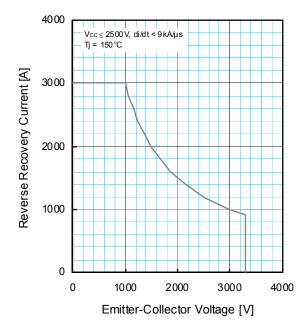
REVERSE BIAS SAFE OPERATING AREA (RBSOA)



SHORT CIRCUIT SAFE OPERATING AREA (SCSOA)



FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)



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